

MECHANICAL DATA

Module dimension Viewing area

ITEM

Active area

Mounting hole

Dot size Dot pitch STANDARD VALUE

45.24 x 29.14 x 2.05

37.056 x 19.52 35.056 x 17.52

0.258 x 0.258

0.274 x 0.274

n/a

Vishay

128 x 64 Graphic OLED

UNIT

mm

FEATURES

- Type: graphic
- Display format: 128 x 64 dots
- Built-in controller: SSD1305
- Duty cycle: 1/64
- +3 V power supply
- Interface: 6800, 8080, serial, and I²C
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

ABSOLUTE MAXIMUM RATINGS										
ITEM	SYMBOL	STANDAF	UNIT							
	STINDUL	MIN.	MAX.	UNIT						
Supply voltage for logic ⁽¹⁾⁽²⁾	V _{DD}	-0.3	4	v						
Supply voltage for display ⁽¹⁾⁽²⁾	V _{CC}	0	15	v						
Operating temperature	T _{OP}	-40	+80	°C						
Storage temperature	T _{STG}	-40	+80	U						

Notes

 $^{(1)}\,$ All the above voltages are on the basis of "V_{SS} = 0 V".

(2) When this module is used beyond the above absolute maximum ratings, permanent breakage of the module may occur. Also, for normal operations, it is desirable to use this module under the conditions according to section 6 "Electrical Characteristics". If this module is used beyond these conditions, malfunctioning of the module can occur and the reliability of the module may deteriorate.

ELECTRICAL CHARACTERISTICS										
ITEM	SYMBOL	CONDITION	ST	STANDARD VALUE						
	STIVIDOL	CONDITION	MIN.	TYP.	MAX.	UNIT				
Supply voltage for logic	V _{DD}	-	2.8	3.0	3.3					
Supply voltage for display	V _{CC}	-	10	12	15					
Input high voltage	V _{IH}	-	0.8 V _{DD}	-	V _{DD}	v				
Input low voltage	VIL	-	0	-	0.2 V _{DD}	v				
Output high voltage	V _{OH}	-	0.9 V _{DD}	-	V _{DD}					
Output low voltage	V _{OL}	-	0	-	0.1 V _{DD}					
50 % check board operating current	I _{CC}	$V_{CC} = 12 V$	20	22	25	mA				
CIEx (white)		(CIE1931)	0.26	0.28	0.30					
CIEy (white)		(CIE1931)	0.30	0.32	0.34					

OPTIONS				
		EMITTING COLOR		
YELLOW	GREEN	RED	BLUE	WHITE
-	-	-	-	Yes

Revision: 14-Dec-16

1 For technical questions, contact: <u>displays@vishay.com</u> Document Number: 37901

Pb-free

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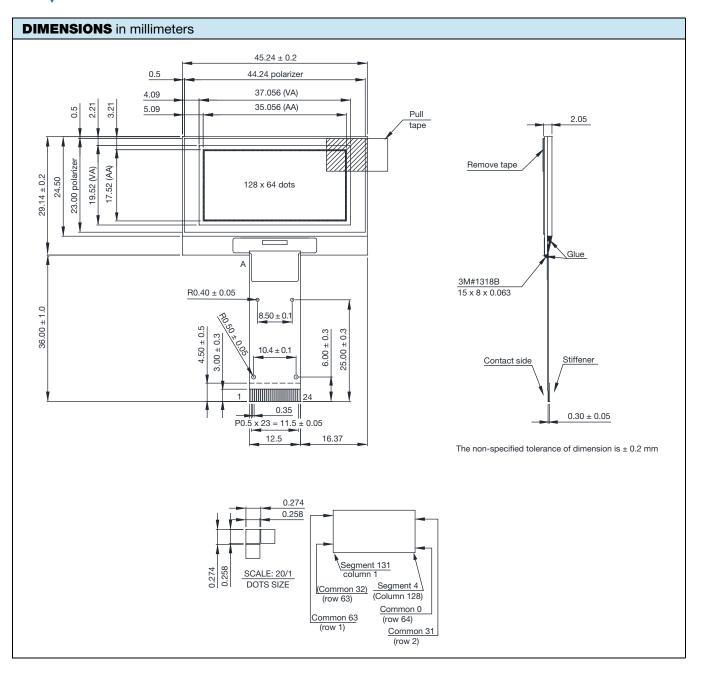
INTERFACE PIN FUNCTION								
PIN NO.	SYMBOL			FUNCTION				
1	NC (GND)	The supporting pins	Reserved pin (supporting pin) The supporting pins can reduce the influences from stresses on the function pins. These pins must be connected to external ground.					
2	V _{LSS}	Ground of analog cir This is an analog gro	rcuit ound pin. It should be	e connected to V _{SS} e	xternally.			
3	V _{SS}	Ground of logic circl This is a ground pin.		ence for the logic pin	is. It must be conne	ected to external ground	d.	
4	NC	Reserved pin The NC pins betwee	n function pins are re	eserved for compatib	le and flexible desi	gn.		
5	V _{DD}	Power supply for log This is a voltage sup	gic circuit pply pin. It must be co	onnected to external	source.			
6	BS1	Communicating prot These pins are MCU	tocol select I interface selection i	nput. See the followir	ng table:			
			68XX-parallel	80XX-parallel	Serial	l ² C		
		BS1	0	1	0	1		
7	BS2	BS2	1	1	0	0		
8	CS#	Chip select This pin is the chip s	elect input. The chip i	s enabled for MCU c	ommunication only	when CS# is pulled low	v.	
9	RES#	Power reset for cont This pin is reset sign	roller and driver al input. When the pi	in is low, initialization	of the chip is exec	uted.		
10	D / C#	display data. When t For detail relationshi the pin is pulled high	mmand control pin. he pin is pulled low, t p to MCU interface s n and serial interface at SDIN will be transf	he input at D7 to D0 ignals, please refer to mode is selected, the	will be transferred to the timing charact e data at SDIN is tre	t D7 to D0 is treated as o the command register eristics diagrams. Wher eated as data. When it is ode, this pin acts as SA0	er. en is	
11	R / W#	as read / write (R / W mode. When 80XX interfac	erface input. When in V#) selection input. F	Pull this pin to "high" this pin will be the	for read mode and write (WR#) input.	sor, this pin will be used I pull it to "low" for write Data write operation is	te	
12	E / RD#	Read / write enable This pin is MCU inte as the enable (E) sigr low. When connecting to	or read rface input. When in nal. Read / write opera	terfacing to a 68XX-s ation is initiated wher ssor, this pin receive	series microprocess In this pin is pulled hi	sor, this pin will be used gh and the CS# is pulled Inal. Data read operatior	d	
13 to 20	D0 to D7	serial mode is select When I ² C mode is	t bi-directional data ted, D1 will be the se	rial data input SDIN 1 should be tired to	and D0 will be the	essor's data bus. Wher serial clock input SCLK as SDA _{out} and SDA _{in} ir	۲.	
21	I _{REF}				e connected betwe	een this pin and V _{SS} . Se	ət	
22	V _{COMH}	This pin is the input p	Voltage output high level for COM signal This pin is the input pin for the voltage output high level for COM signals. A capacitor should be connected between this pin and V_{SS} .					
23	V _{CC}	Power supply for OE This is the most pos	EL panel itive voltage supply p	bin of the chip. It mus	t be supplied exter	nally.		
24	GND	Reserved pin (supporting pins) The supporting pins connected to extern	can reduce the influ	ences from stresses	s on the function pi	ins. These pins must be	e	

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OLED-1280064B-WPP3N00000





1.Module Classification Information

<u>OLE</u>	<u>D -128 0</u> 2 3	064	B	W	P	P	3	N	0	0	000
1	2 3	4	5	6	7	8	9	10	11	12	13
1	Brand : Vishay Ir	ntertechnol	ogy, In	IC.							
2	Horizontal Forma	at: 128 co	lumns								
3	Display Type : N	→Characte	er Type	e, H→(Graph	іс Тур	e, Y-	→Tab ⁻	Гуре,	O→C	og Type
4	Vertical Format:	64 Lines									
5	Serials code: B							050			
		A : Ambe	r					RED			
6	Emitting Color	B : Blue	_					Full c			
-	g =	G : Greer						White			
		Y : Yellov	v Gree	en			Li	Yellov	V		
7	Polarizer	P:With F	Polariz	er; N:	Witho	ut Po	larize	r			
8	Display Mode	P : Passi	ve Ma	trix ; A	: Activ	e Mat	rix				
9	Driver Voltage	3: 3.0 V; 5	5: 5.0\	/							
10	Touch Panel	N : Witho	ut tou	ch pan	el; T:	With t	ouch	panel			
		0 : Stand	ard ty	ре							
		1. Sunlig	ht Rea	adable	type						
11	Products type	2. Trans	parent	OLED) (TOL	ED)					
		3. Flexib	le OLE	ED							
		4. OLED	for Lig	ghting							
		product gra	ades:								
		0 : Stand	ard(A-	level)							
		2 : B-leve	el								
12	Product grades	3 : C-level									
		4 : high c		A-leve	el)						
		5 : Custon	-		,						
		Application		-	r(000~	·ZZZ)					
13	Serial No.		-		•	,					

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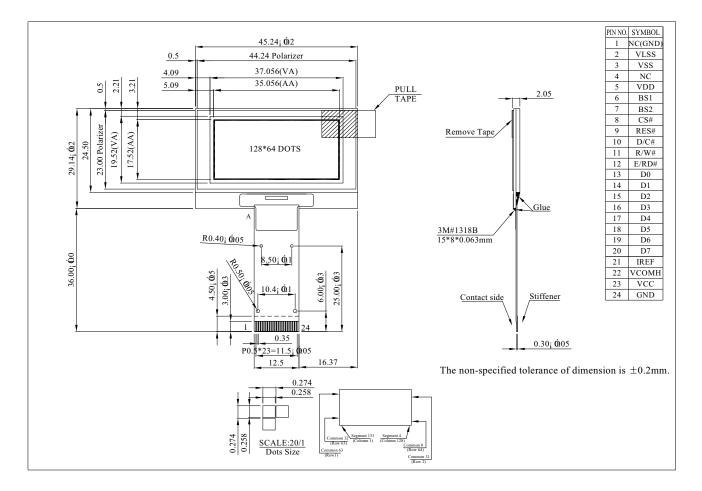


2.General Specification

ltem	Dimension	Unit			
Dot Matrix	128 x 64	_			
Module dimension	45.24 × 29.14 × 2.05 (mm)	mm			
Active Area	35.056 × 17.52 (mm)	mm			
Pixel Size	0.258 × 0.258 (mm)	mm			
Pixel Pitch	0.274 × 0.274 (mm)	mm			
Display Mode	Passive Matrix				
Display Color	White				
Drive Duty	1/64 Duty				
Controller IC	SSD1305				

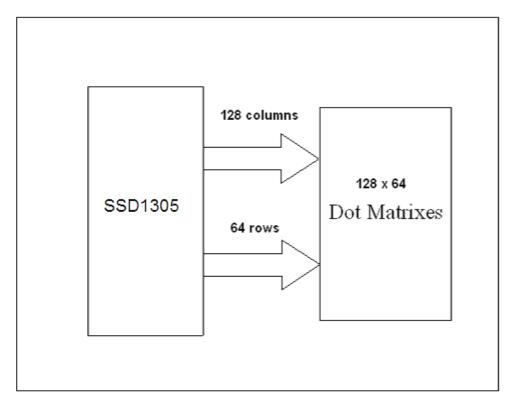


3. Contour Drawing & Block Diagram





FUNCTION BLOCK DIAGRAM





4. Interface Pin Function

Pin No.	Symbol	Function				
1	NC(GND)	<i>Reserved Pin (Supporting Pin)</i> The supporting pins can reduce the influences from stresses on the function pins. These pins must be connected to external ground.				
2	VLSS	<i>Ground of An</i> This is an ana externally.		n. It should be	e connected to	o VSS
3	VSS	<i>Ground of Lo</i> This is a grou must be conn	nd pin. It also	acts as a refendation of a contract of a con	rence for the	logic pins. It
4	NC	<i>Reserved Pin</i> The N.C. pins and flexible d	s between fun	ction pins are	reserved for a	compatible
5	VDD	<i>Power Supply</i> This is a volta source.		<i>rcuit</i> n. It must be co	onnected to ex	xternal
6	BS1		<i>ng Protocol S</i> are MCU inter	<i>elect</i> face selection	input. See th	e following
7	BS2	BS1 BS2	68XX-parallel 0 1	80XX-parallel 1 1	Serial 0 0	12C 1 0
8	CS#			input. The chi when CS# is		for
9	RES#	Power Reset j	for Controller eset signal inp			itialization of
10	D/C#	high, the inpu pulled low, th register. For c refer to the Ti When the pin the data at SD at SDIN will	Data/Comman at at D7~D0 is the input at D7- detail relations iming Charact is pulled high DIN is treated be transferred	d control pin. treated as dis D0 will be tr ship to MCU i teristics Diagra and serial int as data. When to the comma we address sele	play data. Wh ansferred to t nterface signa ams. erface mode it is pulled lo and register. I	hen the pin is he command als, please is selected, pw, the data



		Read/Write Select or Write
		This pin is MCU interface input. When interfacing to a
		68XX-series microprocessor, this pin will be used as Read/Write
11	R/W#	(R/W#) selection input. Pull this pin to "High" for read mode and
		pull it to "Low" for write mode.
		When 80XX interface mode is selected, this pin will be the Write
		(WR#) input. Data write operation is initiated when this pin is
		pulled low and the CS# is pulled low.
		Read/Write Enable or Read
		This pin is MCU interface input. When interfacing to a
		68XX-series microprocessor, this pin will be used as the
12	E/RD#	Enable (E) signal. Read/write operation is initiated when this pin is pulled high and the CS# is pulled low.
		When connecting to an 80XX-microprocessor, this pin receives the
		Read (RD#) signal. Data read operation is initiated when this pin is
		pulled low and CS# is pulled low.
		Host Data Input/Output Bus
		These pins are 8-bit bi-directional data bus to be connected to the
	D0~D7	microprocessor's data bus. When serial mode is selected, D1 will
13~20		be the serial data input SDIN and D0 will be the serial clock input
		SCLK. When I2C mode is selected, D2 & D1 should be tired
		together and serve as SDAout & SDAin in application and D0 is
		the serial clock input SCL.
		Current Reference for Brightness Adjustment
21	IREF	This pin is segment current reference pin. A resistor should be
	IKEF	connected between this pin and VSS. Set the current lower than
		10μΑ.
		Voltage Output High Level for COM Signal
22	VCOMH	This pin is the input pin for the voltage output high level for COM
	V COMIT	signals. A capacitor should be connected between this pin and
		VSS.
23		Power Supply for OEL Panel
23	VCC	This is the most positive voltage supply pin of the chip.
		It must be supplied externally.
24	a 1 -	Reserved Pin (Supporting Pin)
24	GND	The supporting pins can reduce the influences from stresses on the
		function pins. These pins must be connected to external ground.



5.Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit	Notes
Supply Voltage for Logic	VDD	-0.3	4	V	1, 2
Supply Voltage for Display	VCC	0	15	V	1, 2
Operating Temperature	TOP	-40	+80	°C	-
Storage Temperature	TSTG	-40	+80	°C	-

Note 1: All the above voltages are on the basis of "VSS = 0V".

Note 2: When this module is used beyond the above absolute maximum ratings, permanent breakage of the module may occur. Also, for normal operations, it is desirable to use this module under the conditions according to Section 6 "Electrical Characteristics". If this module is used beyond these conditions, malfunctioning of the module can occur and the reliability of the module may deteriorate



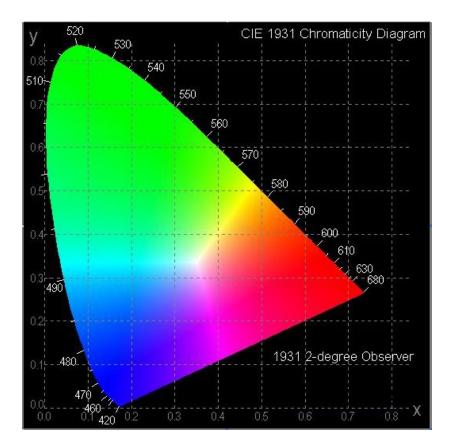
6.Electrical Characteristics

ltem	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage for Logic	VDD	_	2.8	3.0	3.3	V
Supply Voltage for Display	VCC	—	10	12	15	V
High Level Input	VIH		0.8×VDD		VDD	V
Low Level Input	VIL	—	0	_	0.2×VDD	V
High Level Output	VOH	—	0.9×VDD	_	VDD	V
Low Level Output	VOL	—	0	_	0.1×VDD	V
50% Check Board operatir Current	ng	VCC =12V	20	22	25	mA



7.Optical Characteristics

ltem	Symbol	Condition	Min	Тур	Max	Unit
View Angle	θ(V)		160			deg
	(H)φ		160			deg
Contrast Ratio	CR	Dark	2000:1		-	—
Response Time	T rise			10		μs
itesponse nine	T fall	—		10		μs
Display with 50% check	Board Brig	ghtness	70	90		cd/m2
CIEx(White)		(CIE1931)	0.26	0.28	0.30	
CIEy(White)		(CIE1931)	0.30	0.32	0.34	







8.OLED Lifetime

ITEM	Conditions	Min	Тур	Remark
Operating Life Time	Ta=25℃ / Initial 50% check board brightness Typical Value	40,000 Hrs	50,000 Hrs	Note

Notes:

- 1. Life time is defined the amount of time when the luminance has decayed to <50% of the initial value.
- 2. This analysis method uses life data obtained under accelerated conditions to extrapolate an estimated probability density function (*pdf*) for the product under normal use conditions.
- 3. Screen saving mode will extend OLED lifetime.



9.Reliability

Content of Reliability Test

Environmenta	I Test		
Test Item	Content of Test	Test Condition	Applicable Standard
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80	
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-40 □ 240hrs	
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	80 □ 240hrs	
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-40 □ 240hrs	
High Temperature/ Humidity Storage	Endurance test applying the high temperature and high humidity storage for a long time.	60□,90%RH 240hrs	
Temperature Cycle	Endurance test applying the low and high temperature cycle. -40 25 80 30min 5min 30min 1 cycle	-40□/80□ 100 cycles	
Mechanical Te	st		
Vibration test	Endurance test applying the vibration during transportation and using.	10~22Hz→1.5mmp-p 22~500Hz→1.5G Total 0.5hr	
Shock test	Constructional and mechanical endurance test applying the shock during transportation.	50G Half sin wave 11 ms 3 times of each direction	
Atmospheric pressure test	Endurance test applying the atmospheric pressure during transportation by air.	115mbar 40hrs	
Others	-		
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=800V,RS=1.5kΩ CS=100pF 1 time	

*** Supply voltage for OLED system =Operating voltage at 25° C



Test and measurement conditions

- 1. All measurements shall not be started until the specimens attain to temperature stability. After the completion of the described reliability test, the samples were left at room temperature for 2 hrs prior to conducting the failure test at 23±5°C; 55±15% RH.
- 2. All-pixels-on is used as operation test pattern.
- 3. The degradation of Polarizer are ignored for High Temperature storage, High Temperature/ Humidity Storage, Temperature Cycle

Evaluation criteria

- 1. The function test is OK.
- 2. No observable defects.
- 3. Luminance: > 50% of initial value.
- 4. Current consumption: within ± 50% of initial value.

APPENDIX:

RESIDUE IMAGE

Because the pixels are lighted in different time, the luminance of active pixels may reduce or differ from inactive pixels. Therefore, the residue image will occur. To avoid the residue image, every pixel needs to be lighted up uniformly.



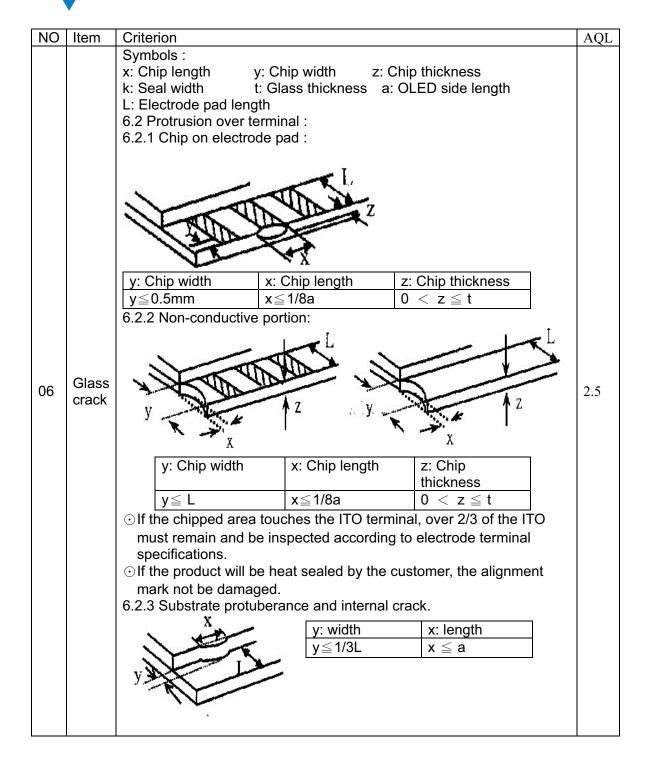
10.Inspection specification

NO	Item	Criterion			AQL		
01	Electrical Testing	 1.1 Missing vertical, horizontal segment, segment contrast defect. 1.2 Missing character , dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 OLED viewing angle defect. 1.7 Mixed product types. 1.8 Contrast defect. 			0.65		
02	Black or white spots on OLED (display only)	 2.1 White and black spots on display ≦0.25mm, no more than three white or black spots present. 2.2 Densely spaced: No more than two spots or lines within 3mm. 			2.5		
03	OLED black spots, white spots, contamina tion (non-displ ay)	3.1 Round type following drawin $\Phi=(x + y)/2$		-	SIZE $\Phi \le 0.10$ $0.10 <$ $\Phi \le 0.20$ $0.20 <$ $\Phi \le 0.25$ $0.25 < \Phi$	Acceptable Q TY Accept no dense 2 1 0	2.5
		3.2 Line type : (/	As followin Length L≦3.0 L≦2.5 	Wid W≤ 0.0 0.0	• /	Acceptable Q TY Accept no dense 2 As round type	2.5
04	Polarizer bubbles	If bubbles are vis judge using blac specifications, n to find, must che specify direction	k spot ot easy eck in	Φ≦ 0.2 0.5 1.0	$e \Phi$ ≤0.20 0 < Φ ≤ 0.50 0 < Φ ≤ 1.00 0 < Φ al Q TY	Acceptable Q TY Accept no dense 3 2 0 3	2.5

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NO	Item	Criterion			AQL
05	Scratches	Follow NO.3 OLED black spots, white spots, contamination			
			t: Glass thickness a	Chip thickness : OLED side length	
		 6.1 General glass chip : 6.1.1 Chip on panel surface and crack between panels: X 			
		z: Chip thickness	y: Chip width	x: Chip length	
06	Chipped	Z≦1/2t	Not over viewing area	x≦1/8a	2.5
	glass	$1/2t < z \leq 2t$	Not exceed 1/3k	x≦1/8a	
		⊙ If there are 2 or mo 6.1.2 Corner crack: \overrightarrow{z} : Chip thickness $\overrightarrow{Z} \leq 1/2t$	ore chips, x is total len	ngth of each chip. x: Chip length x≦1/8a	
		$1/2t < z \le 2t$	Not exceed 1/3k	x≦1/8a	
⊙ If there are 2 or more chips, x is the total length of ea				l length of each chip.	

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NO	Item	Criterion	AQL
07	Cracked glass	The OLED with extensive crack is not acceptable.	2.5
08	Backlight elements	 8.1 Illumination source flickers when lit. 8.2 Spots or scratched that appear when lit must be judged. Using OLED spot, lines and contamination standards. 8.3 Backlight doesn't light or color wrong. 	0.65 2.5 0.65
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination.9.2 Bezel must comply with job specifications.	2.5 0.65
10	PCB、COB	 10.1 COB seal may not have pinholes larger than 0.2mm or contamination. 10.2 COB seal surface may not have pinholes through to the IC. 10.3 The height of the COB should not exceed the height indicated in the assembly diagram. 10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places. 10.5 No oxidation or contamination PCB terminals. 10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts. 10.7 The jumper on the PCB should conform to the product characteristic chart. 10.8 If solder gets on bezel tab pads, OLED pad, zebra pad or screw hold pad, make sure it is smoothed down. 	 2.5 2.5 2.5 2.5 0.65 0.65 2.5
11	Soldering	 11.1 No un-melted solder paste may be present on the PCB. 11.2 No cold solder joints, missing solder connections, oxidation or icicle. 11.3 No residue or solder balls on PCB. 11.4 No short circuits in components on PCB. 	2.5 2.5 2.5 0.65



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NO	Item	Criterion	AQL
NO 12	Item General appearance	 12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP. 12.2 No cracks on interface pin (OLB) of TCP. 12.3 No contamination, solder residue or solder balls on product. 12.4 The IC on the TCP may not be damaged, circuits. 12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it cause the interface pin to sever. 12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color. 12.7 Sealant on top of the ITO circuit has not hardened. 12.8 Pin type must match type in specification sheet. 	AQL 2.5 0.65 2.5 2.5 2.5 2.5 2.5 0.65 0.65 0.65
		 12.9 OLED pin loose or missing pins. 12.10 Product packaging must the same as specified on packaging specification sheet. 12.11 Product dimension and structure must conform to product specification sheet. 	0.65



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Check Item	Classification	Criteria
No Display	Major	
Missing Line	Major	
Pixel Short	Major	
Darker Short	Major	
Wrong Display	Major	
Un-uniform B/A x 100% < 70% A/C x 100% < 70%	Major	Image: state

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11.Precautions in use of OLED Modules

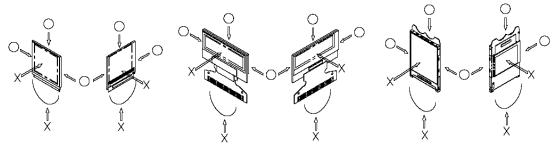
Modules

- (1)Avoid applying excessive shocks to module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the
- components of OLED display module.
- (3)Don't disassemble the OLED display module.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist OLED display module.
- (6)Soldering: only to the I/O terminals.
- (7)Storage: please storage in anti-static electricity container and clean environment.
- (8)It's pretty common to use "Screen Saver" to extend the lifetime and Don't use fix information for long time in real application.
- (9)Don't use fixed information in OLED panel for long time, that will extend "screen burn" effect time..
- (10)Vishay has the right to change the passive components, including R2and R3 adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (11)Vishay has the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Vishay has the right to modify the version.)
- 11.1. Handling Precautions
- (1) Since the display panel is being made of glass, do not apply mechanical impacts such us dropping from a high position.
- (2) If the display panel is broken by some accident and the internal organic substance leaks out, be careful not to inhale nor lick the organic substance.
- (3) If pressure is applied to the display surface or its neighborhood of the OLED display module, the cell structure may be damaged and be careful not to apply pressure to these sections.
- (4) The polarizer covering the surface of the OLED display module is soft and easily scratched. Please be careful when handling the OLED display module.
- (5) When the surface of the polarizer of the OLED display module has soil, clean the surface. It takes advantage of by using following adhesion tape.
 - * Scotch Mending Tape No. 810 or an equivalent
 - Never try to breathe upon the soiled surface nor wipe the surface using cloth containing solvent
 - such as ethyl alcohol, since the surface of the polarizer will become cloudy.
 - Also, pay attention that the following liquid and solvent may spoil the polarizer:
 - * Water
 - * Ketone
 - * Aromatic Solvents
- (6) Hold OLED display module very carefully when placing OLED display module into the System housing. Do not apply excessive stress or pressure to OLED display module. And, do not over bend the film with electrode pattern layouts.

These stresses will influence the display performance. Also, secure sufficient rigidity for the outer cases.



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(7) Do not apply stress to the LSI chips and the surrounding molded sections.

(8) Do not disassemble nor modify the OLED display module.

(9) Do not apply input signals while the logic power is off.

(10) Pay sufficient attention to the working environments when handing OLED display modules to prevent occurrence of element breakage accidents by static electricity.

- * Be sure to make human body grounding when handling OLED display modules.
- * Be sure to ground tools to use or assembly such as soldering irons.
- * To suppress generation of static electricity, avoid carrying out assembly work under dry environments.

* Protective film is being applied to the surface of the display panel of the OLED display module. Be careful since static electricity may be generated when exfoliating the protective film.

(11) Protection film is being applied to the surface of the display panel and removes the protection film before assembling it. At this time, if the OLED display module has been stored for a long period of time, residue adhesive material of the protection film may remain on the surface of the display panel after removed of the film. In such case, remove the residue material by the method introduced in the above Section 5.

(12) If electric current is applied when the OLED display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful to avoid the above.

11.2. Storage Precautions

(1) When storing OLED display modules, put them in static electricity preventive bags avoiding exposure to direct sun light nor to lights of fluorescent lamps. and, also, avoiding high temperature and high humidity environment or low temperature (less than 0°C) environments.

(We recommend you to store these modules in the packaged state when they were shipped from Vishay Intertechnology Inc.

At that time, be careful not to let water drops adhere to the packages or bags nor let dewing occur with them.

(2) If electric current is applied when water drops are adhering to the surface of the OLED display module, when the OLED display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful about the above.

11.3. Designing Precautions

(1) The absolute maximum ratings are the ratings which cannot be exceeded for OLED display module, and if these values are exceeded, panel damage may be happen.

(2) To prevent occurrence of malfunctioning by noise, pay attention to satisfy the VIL and VIH specifications and, at the same time, to make the signal line cable as short as possible.

(3) We recommend you to install excess current preventive unit (fuses, etc.) to the power circuit (VDD). (Recommend value: 0.5A)

(4) Pay sufficient attention to avoid occurrence of mutual noise interference with the neighboring devices.

(5) As for EMI, take necessary measures on the equipment side basically.



(6) When fastening the OLED display module, fasten the external plastic housing section.

(7) If power supply to the OLED display module is forcibly shut down by such errors as taking out the main battery while the OLED display panel is in operation, we cannot guarantee the quality of this OLED display module.

* Connection (contact) to any other potential than the above may lead to rupture of the IC.11.4.

Precautions when disposing of the OLED display modules

1) Request the qualified companies to handle industrial wastes when disposing of the OLED display modules. Or, when burning them, be sure to observe the environmental and hygienic laws and regulations.

11.5. Other Precautions

- (1) When an OLED display module is operated for a long of time with fixed pattern may remain as an after image or slight contrast deviation may occur.
- Nonetheless, if the operation is interrupted and left unused for a while, normal state can be restored. Also, there will be no problem in the reliability of the module.
- (2) To protect OLED display modules from performance drops by static electricity rapture, etc., do not touch the following sections whenever possible while handling the OLED display modules.
- * Pins and electrodes
- * Pattern layouts such as the TCP & FPC
- (3) With this OLED display module, the OLED driver is being exposed. Generally speaking, semiconductor elements change their characteristics when light is radiated according to the principle of the solar battery. Consequently, if this OLED driver is exposed to light, malfunctioning may occur.
- * Design the product and installation method so that the OLED driver may be shielded from light in actual usage.
- * Design the product and installation method so that the OLED driver may be shielded from light during the inspection processes.
- (4) Although this OLED display module stores the operation state data by the commands and the indication data, when excessive external noise, etc. enters into the module, the internal status may be changed. It therefore is necessary to take appropriate measures to suppress noise generation or to protect from influences of noise on the system design.
- (5) We recommend you to construct its software to make periodical refreshment of the operation statuses (re-setting of the commands and re-transference of the display data) to cope with catastrophic noise.
- (6)Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.
- (7)Our company will has the right to upgrade and modify the product function.



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